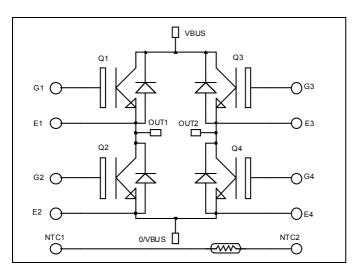


Full - Bridge NPT IGBT Power Module





E4 🛱

E2 0

G2 🛭

O/VBUS

Application

- Welding converters
- Switched Mode Power Supplies
- Uninterruptible Power Supplies
- Motor control

Features

- Non Punch Through (NPT) Fast IGBT
 - Low voltage drop
 - Low tail current
 - Switching frequency up to 50 kHz
 - Soft recovery parallel diodes
 - Low diode VF
 - Low leakage current
 - RBSOA and SCSOA rated
- Kelvin emitter for easy drive
- Very low stray inductance
 - Symmetrical design
 - Lead frames for power connections
- Internal thermistor for temperature monitoring
- High level of integration

Benefits

- Outstanding performance at high frequency operation
- Stable temperature behavior
- Very rugged
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Solderable terminals both for power and signal for easy PCB mounting
- Easy paralleling due to positive T_C of V_{CEsat}
- Low profile
- RoHS compliant

Absolute maximum ratings

Ø G3

® E3

VBUS

Symbol	Parameter		Max ratings	Unit
V_{CES}	Collector - Emitter Breakdown Voltage		1200	V
T	Continuous Collector Current	$T_c = 25^{\circ}C$	100	
I_{C}	Continuous Conector Current	$T_c = 80$ °C	75	A
I_{CM}	Pulsed Collector Current	$T_c = 25^{\circ}C$	150	
V_{GE}	Gate – Emitter Voltage		±20	V
P_{D}	Maximum Power Dissipation	$T_c = 25^{\circ}C$	500	W
RBSOA	Reverse Bias Safe Operating Area	$T_j = 150^{\circ}C$	150A @ 1200V	

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com

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OUT2

OUT1

NTC2 🌡



All ratings @ $T_j = 25$ °C unless otherwise specified

Electrical Characteristics

Symbol	Characteristic	Test Conditions		Min	Тур	Max	Unit
Ţ	Zero Gate Voltage Collector Current	$V_{GE} = 0V$	$T_j = 25$ °C			250	μA
I_{CES}	Zero Gate Voltage Collector Current	$V_{CE} = 1200V$	$T_j = 125$ °C			500	μΑ
V	Collector Emitter saturation Voltage	$V_{GE} = 15V$	$T_j = 25$ °C		3.2	3.7	V
$V_{CE(sat)}$	Conector Emitter saturation voltage	$I_C = 75A$	$T_j = 125$ °C		3.9		V
$V_{GE(th)}$	Gate Threshold Voltage	$V_{GE} = V_{CE}, I_{C} = 2.5 \text{ mA}$		4.5		6.5	V
I_{GES}	Gate – Emitter Leakage Current	$V_{GE} = \pm 20V, V_{CE} = 0V$				±500	nA

Dynamic Characteristics

•	Characteristic	Test Condition	ns	Min	Тур	Max	Unit
C_{ies}	Input Capacitance	$V_{GE} = 0V$			5.1		
C_{oes}	Output Capacitance	$V_{CE} = 25V$	$V_{CE} = 25V$ $f = 1MHz$		0.7		nF
C_{res}	Reverse Transfer Capacitance	f = 1MHz			0.4		
Q_{G}	Gate charge	V _{GE} =±15V, I _C V _{CE} =600V	V _{GE} =±15V, I _C =75A V _{CE} =600V		0.8		μС
$T_{d(on)}$	Turn-on Delay Time	Inductive Swi	tching (25°C)		120		
T_{r}	Rise Time	$V_{GE} = 15V$			50		ns
$T_{d(off)}$	Turn-off Delay Time	$V_{Bus} = 600V$ $I_{C} = 75A$			310		
$T_{\rm f}$	Fall Time	$R_{G} = 7.5\Omega$			20		
$T_{d(on)}$	Turn-on Delay Time		tching (125°C)		130		
T_{r}	Rise Time	$V_{GE} = 15V$			60		ns
$T_{d(off)}$	Turn-off Delay Time	$I_{\rm C} = 75A$	$V_{Bus} = 600V$		360		
$T_{\rm f}$	Fall Time	$R_G = 7.5\Omega$			30		
E _{on}	Turn-on Switching Energy	$V_{GE} = \pm 15V$ $V_{Bus} = 600V$	$T_j = 125$ °C		9		mJ
E_{off}	Turn-off Switching Energy	$I_C = 75A$ $R_G = 7.5\Omega$	$T_j = 125$ °C		4		1113
I_{sc}	Short Circuit data	$V_{GE} \le 15V$; $V_{DE} \le 10\mu s$; $V_{DE} \le 10\mu$		·	450		A

Reverse diode ratings and characteristics

Symbol	Characteristic	Test Conditions		Min	Тур	Max	Unit
V_{RRM}	Maximum Peak Repetitive Reverse Voltage			1200			V
I_{RM}	Maximum Reverse Leakage Current	V _R =1200V	$T_j = 25$ °C			250	μΑ
*KM	Waximum Reverse Bearage Carrent	VR 1200 V	$T_{j} = 125^{\circ}C$			500	μ1
I_F	DC Forward Current		Tc = 80°C		50		A
N/	D'. I. F I.W. k	$I_F = 50A$	$T_j = 25^{\circ}C$		2.1		V
V_{F}	Diode Forward Voltage		$T_j = 125$ °C		1.9		
4	D Ti'm.		$T_j = 25$ °C		95		
t_{rr}	Reverse Recovery Time		$T_j = 125$ °C		190		ns
0	Payarga Pagayary Chargo	$ \begin{aligned} I_F &= 50A \\ V_R &= 600V \\ \text{di/dt} &= 1500\text{A/}\mu\text{s} \end{aligned} $	$T_j = 25$ °C		4.2		C
Q_{rr}	Reverse Recovery Charge		$T_{j} = 125^{\circ}C$		9		μC
Е	Davarra Dagayary Engray		$T_j = 25$ °C		1.5		m I
E_{r}	Reverse Recovery Energy		$T_j = 125$ °C		3		mJ



Temperature sensor NTC (see application note APT0406 on www.microsemi.com for more information).

Symbol	Characteristic		Min	Тур	Max	Unit
R ₂₅	Resistance @ 25°C	ce @ 25°C		50		kΩ
$\Delta R_{25}/R_{25}$				5		%
$B_{25/85}$	$T_{25} = 298.15 \text{ K}$			3952		K
$\Delta \mathrm{B/B}$		T _C =100°C		4		%

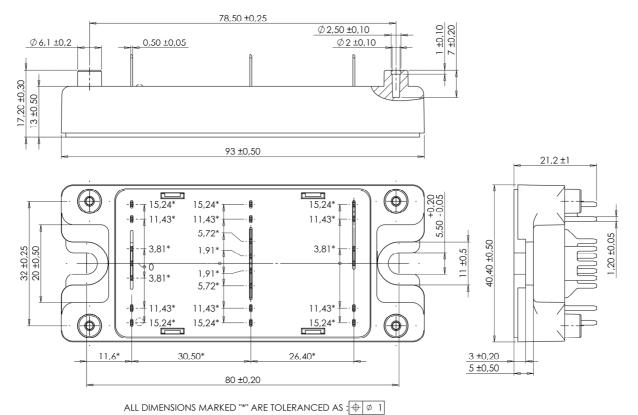
$$R_T = \frac{R_{25}}{\exp \left[B_{25/85} \left(\frac{1}{T_{25}} - \frac{1}{T} \right) \right]} \quad \text{T: Thermistor temperature}$$

$$R_T: \text{ Thermistor value at T}$$

Thermal and package characteristics

Symbol	Characteristic			Min	Тур	Max	Unit
R_{thJC}	Junction to Case Thermal Resistance		IGBT			0.25	°C/W
			Diode			0.6	C/ VV
V_{ISOL}	RMS Isolation Voltage, any terminal to case t =1 min, 50/60Hz		4000			V	
T_{J}	Operating junction temperature range			-40		150	
T_{STG}	Storage Temperature Range		-40		125	°C	
$T_{\rm C}$	Operating Case Temperature					100	
Torque	Mounting torque	To heatsink	M5	2.5		4.7	N.m
Wt	Package Weight					160	g

SP4 Package outline (dimensions in mm)

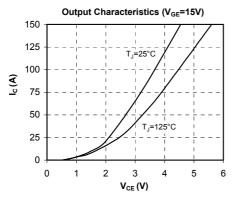


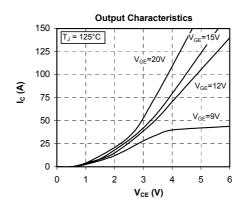
See application note APT0501 - Mounting Instructions for SP4 Power Modules on www.microsemi.com

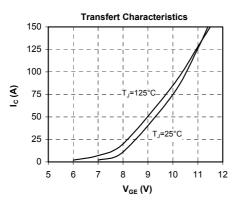
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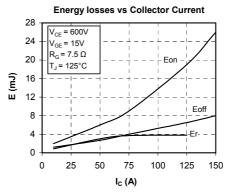


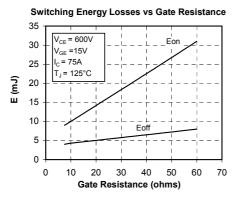
Typical Performance Curve

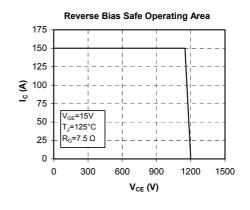


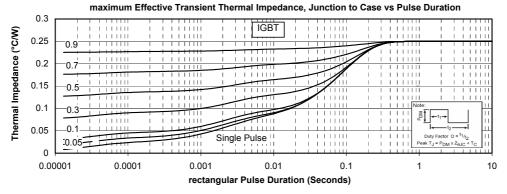






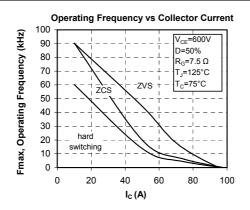


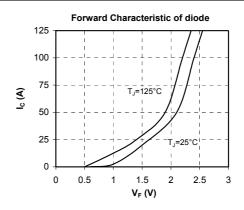


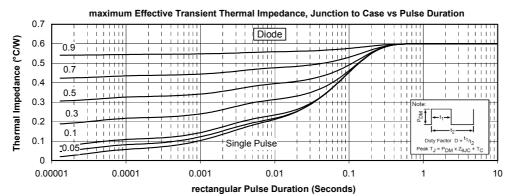


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FD400R12KE3 FD400R33KF2C-K FD401R17KF6C_B2 FD-DF80R12W1H3_B52 FF100R12KS4 FF1200R17KE3_B2 FF150R12KE3G

FF200R06KE3 FF200R06YE3 FF200R12KT3 FF200R12KT3_E FF200R12KT4 FF200R17KE3 FF300R06KE3_B2 FF300R12KE4_E

FF300R12KS4HOSA1 FF300R12ME4_B11 FF300R12MS4 FF300R17ME4 FF450R12ME4P FF450R17IE4 FF600R12IE4V

FF600R12IP4V FF800R17KP4_B2 FF900R12IE4V MIXA30W1200TED MIXA450PF1200TSF FP06R12W1T4_B3 FP100R07N3E4

FP100R07N3E4_B11 FP10R06W1E3_B11 FP10R12W1T4_B11 FP10R12YT3 FP10R12YT3_B4 FP150R07N3E4 FP15R12KT3

FP15R12W2T4